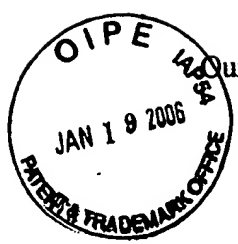


AF  
IPW



RESPONSE UNDER 37 C.F.R. § 1.116  
-- EXPEDITED PROCEDURE --  
EXAMINING GROUP 2100

Our Docket No.: 042390.P9043

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Subramaniyam

Examiner: Phan, Raymond Ngan

Application No.: 09/669,034

Art Group: 2111

Filed: September 25, 2000

For: A Method and Apparatus for Lowering  
the Die Temperature of a  
Microprocessor and Maintaining the  
Temperature Below the Die Burn Out

RESPONSE AFTER FINAL

Mail Stop: AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Final Office Action mailed on November 16, 2005, which was made final, applicant submits this Amendment After Final Action for consideration.

FIRST CLASS CERTIFICATE OF MAILING/FACSIMILE

I hereby certify that I am causing the above-referenced correspondence to be facsimile transmitted and to be deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated below and that this paper or fee has been addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450

January 17, 2006  
Date of Deposit

Leah Schwenke  
Name of Person Mailing Correspondence

Signature

January 17, 2006  
Date

Docket No.: 042390.P9043  
Application No.: 09/669,034

DO NOT ENTER  
2/1/06  
RP